

Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Drain-to-Source Voltage (V _{DS})	415	V
Gate-to-Source Voltage (V _{GS})	±20	V
Total Package Dissipation	2.5	W
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics @25°C (Unless Otherwise Specified)

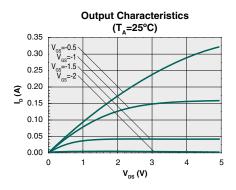
Parameter	Symbol	Conditions	Min	Тур	Max	Units
Gate-to-Source Off Voltage	$V_{GS(off)}$	$I_{D} = 2\mu A, V_{DS} = 10V, V_{DS} = 100V$	-3.6		-2.0	V
Drain-to-Source Leakage Current	1	V _{GS} = -5V, V _{DS} =250V	-	-	20	nA
Diam-to-Source Leakage Guirent	DS(off)	V _{GS} = -5V, V _{DS} =415V	-	-	1	μΑ
Drain Current	I _D	$V_{GS} = -2.7V, V_{DS} = 5V, V_{DS} = 50V$	-	-	5	mA
Diam Guirent		V _{GS} = -0.57V, V _{DS} =5V	130	-	-	mA
On Resistance	R _{DS(on)}	V_{GS} = -0.35V, I_{DS} =50mA	-	8	14	Ω
Gate Leakage Current	I _{GSS}	V _{GS} =10V, V _{GS} =-10V	-	-	0.1	μΑ
Gate Capacitance	C _{ISS}	$V_{DS} = V_{GS} = 0V$	-	-	300	pF

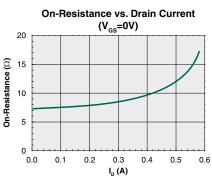
Thermal Characteristics

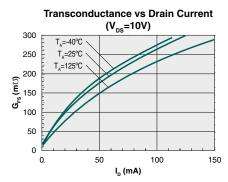
Parameter	Symbol	Conditions	Min	Тур	Max	Units
Thermal Resistance	$R_{ heta JC}$	-	-	-	14	°C/W

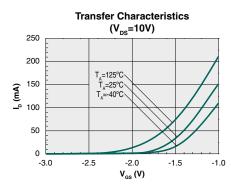


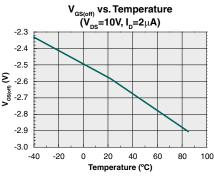
Performance Data*

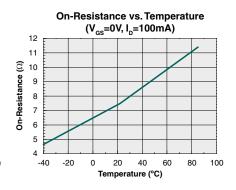


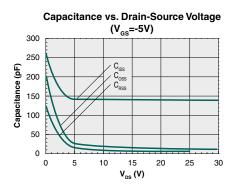


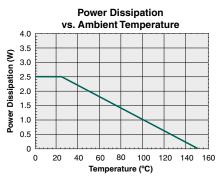


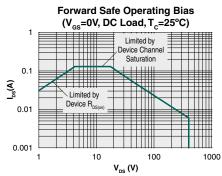












^{*}The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.



Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, IPC/JEDEC J-STD-020, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC5603C	MSL 1

ESD Sensitivity



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time	
CPC5603C	260°C for 30 seconds	

Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable, and the use of a short drying bake may be necessary. Chlorine-based or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

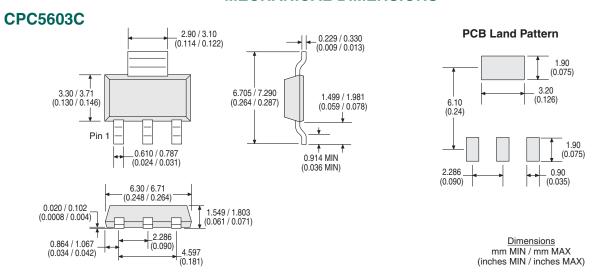




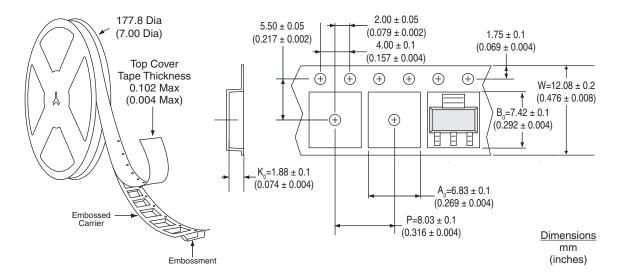




MECHANICAL DIMENSIONS



CPC5603CTR Tape & Reel



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